

TC1054 TC1055 TC1186

## 50mA, 100mA, and 150mA CMOS LDOs with Shutdown and ERROR Output

#### **FEATURES**

- Zero Ground Current for Longer Battery Life
- Very Low Dropout Voltage
- Guaranteed 50mA, 100mA, and 150mA Output (TC1054, TC1055, and TC1186, Respectively)
- High Output Voltage Accuracy
- Standard or Custom Output Voltages
- **■** Power-Saving Shutdown Mode
- ERROR Output Can Be Used as a Low Battery Detector, or Processor Reset Generator
- Over-Current and Over-Temperature Protection
- Space-Saving 5-Pin SOT-23A Package
- Pin Compatible Upgrades for Bipolar Regulators

#### **APPLICATIONS**

- Battery Operated Systems
- Portable Computers
- Medical Instruments
- Instrumentation
- Cellular/GSMS/PHS Phones
- Linear Post-Regulators for SMPS
- Pagers

### ORDERING INFORMATION

Part Number	Package	Junction Temp. Range
TC1054-xxVCT	5-Pin SOT-23A*	- 40°C to +125°C
TC1055-xxVCT	5-Pin SOT-23A*	- 40°C to +125°C
TC1186-xxVCT	5-Pin SOT-23A*	- 40°C to +125°C

### TC1015EV Evaluation Kit for CMOS LDO Family

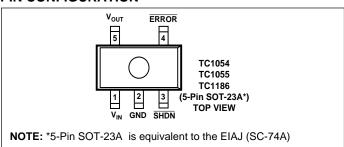
NOTE: \*5-Pin SOT-23A is equivalent to the EIAJ (SC-74A).

#### **Available Output Voltages:**

2.5, 2.7, 2.8, 2.85, 3.0, 3.3, 3.6, 4.0, 5.0 xx indicates output voltages

Other output voltages are available. Please contact Microchip Technology for details.

#### **PIN CONFIGURATION**



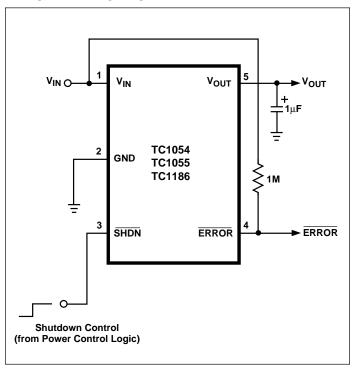
#### **GENERAL DESCRIPTION**

The TC1054, TC1055, and TC1186 are high accuracy (typically  $\pm 0.5\%$ ) CMOS upgrades for older (bipolar) low dropout regulators. Designed specifically for battery-operated systems, the devices' CMOS construction eliminates wasted ground current, significantly extending battery life. Total supply current is typically  $50\mu A$  at full load (20 to 60 times lower than in bipolar regulators!).

The devices' key features include ultra low noise operation, very low dropout voltage — typically 85mV (TC1054); 180mV (TC1055); and 270mV (TC1186) at full load — and fast response to step changes in load. An error output (ERROR) is asserted when the devices are out-of-regulation (due to a low input voltage or excessive output current). ERROR can be used as a low battery warning or as a processor RESET signal (with the addition of an external RC network). Supply current is reduced to 0.5μA (max) and both V<sub>OUT</sub> and ERROR are disabled when the shutdown input is low. The devices incorporate both overtemperature and over-current protection.

The TC1054, TC1055, and TC1186 are stable with an output capacitor of only  $1\mu F$  and have a maximum output current of 50mA, 100mA, and 150mA, respectively. For higher output current regulators, please see the TC1173 ( $I_{OUT} = 300mA$ ) data sheet.

#### TYPICAL APPLICATION



# 50mA, 100mA, and 150mA CMOS LDOs with Shutdown and Error Output

TC1054 TC1055 TC1186

### **ABSOLUTE MAXIMUM RATINGS\***

Input Voltage	6.5V
Output Voltage	
Power Dissipation	Internally Limited
Operating Temperature Range	$-40^{\circ}$ C $< T_{J} < 125^{\circ}$ C
Storage Temperature	65°C to +150°C
Maximum Voltage on Any Pin	V <sub>IN</sub> +0.3V to - 0.3V
Lead Temperature (Soldering, 10	Sec.)+260°C

\*Stresses above those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only and functional operation of the device at these or any other conditions above those indicated in the operation sections of the specifications is not implied. Exposure to Absolute Maximum Rating conditions for extended periods may affect device reliability.

**ELECTRICAL CHARACTERISTICS:**  $V_{IN} = V_{OUT} + 1V$ ,  $I_L = 100\mu A$ ,  $C_L = 3.3\mu F$ , SHDN  $> V_{IH}$ ,  $T_A = 25^{\circ}C$ , unless otherwise noted. **Boldface** type specifications apply for junction temperatures of  $-40^{\circ}C$  to  $+125^{\circ}C$ .

Symbol	Parameter	<b>Test Conditions</b>	Min	Тур	Max	Units
V <sub>IN</sub>	Input Operating Voltage		_	_	6.0	V
I <sub>OUTMAX</sub>	Maximum Output Current	TC1054 TC1055 TC1186	50 100 150	_ _ _		mA
V <sub>OUT</sub>	Output Voltage	Note 1	V <sub>R</sub> - 2.5%	V <sub>R</sub> ±0.5%	V <sub>R</sub> + 2.5%	V
TCV <sub>OUT</sub>	V <sub>OUT</sub> Temperature Coefficient	Note 2	_	20 <b>40</b>	_	ppm/°C
$\Delta V_{OUT}/\Delta V_{IN}$	Line Regulation	$(V_R + 1V) \le V_{IN} \le 6V$	_	0.05	0.35	%
$\Delta V_{OUT}/V_{OUT}$	Load Regulation TC1054;TC10	055 $I_L = 0.1 \text{mA} \text{ to } I_{\text{OUTMAX}}$ $I_L = 0.1 \text{mA} \text{ to } I_{\text{OUTMAX}}$ (Note 3)	_	0.5 0.5	2 3	%
V <sub>IN</sub> – V <sub>OUT</sub>	Dropout Voltage  TC1055; TC1 TC1186	$I_L = 100 \mu A$ $I_L = 20 m A$ $I_L = 50 m A$ $186 I_L = 100 m A$ $I_L = 150 m A$ $(Note 4)$	_ _ _ _	2 65 85 180 270	120 250 400	mV
I <sub>IN</sub>	Supply Current (Note 8)	$\overline{SHDN} = V_{IH}, I_L = 0$	_	50	80	μΑ
I <sub>INSD</sub>	Shutdown Supply Current	SHDN = 0V	_	0.05	0.5	μΑ
PSRR	Power Supply Rejection Ratio	F <sub>RE</sub> ≤ 1KHz	_	64	_	dB
I <sub>OUTSC</sub>	Output Short Circuit Current	V <sub>OUT</sub> = 0V	_	300	450	mA
$\Delta V_{OUT}/\Delta P_{D}$	Thermal Regulation	Notes 5, 6	_	0.04	_	V/W
T <sub>SD</sub>	Thermal Shutdown Die Temperature	)	_	160	_	°C
$\Delta T_{SD}$	Thermal Shutdown Hysteresis		_	10	_	°C
eN	Output Noise	$I_L = I_{OUT_{MAX}}$	_	260	_	nV/√ <del>Hz</del>
SHDN Input						
V <sub>IH</sub>	SHDN Input High Threshold	V <sub>IN</sub> = 2.5V to 6.5V	45	_	_	%V <sub>IN</sub>
V <sub>IL</sub>	SHDN Input Low Threshold	$V_{IN} = 2.5V \text{ to } 6.5V$	_	_	15	%V <sub>IN</sub>

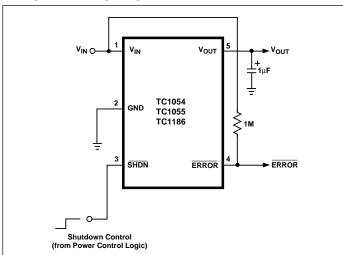
**ELECTRICAL CHARACTERISTICS:**  $V_{IN} = V_{OUT} + 1V$ ,  $I_L = 0.1 \text{mA}$ ,  $C_L = 3.3 \mu\text{F}$ ,  $\overline{\text{SHDN}} > V_{IH}$ ,  $T_A = 25 ^{\circ}\text{C}$ , unless otherwise noted. **BOLDFACE** type specifications apply for junction temperatures of  $-40 ^{\circ}\text{C}$  to  $+125 ^{\circ}\text{C}$ .

Symbol	Parameter	Test Conditions	Min	Тур	Max	Units
ERROR Out	put					
V <sub>INMIN</sub>	Minimum V <sub>IN</sub> Operating Voltage		1.0	_	_	V
$\overline{V_{OL}}$	Output Logic Low Voltage	1 mA Flows to ERROR	_	_	400	mV
$V_{TH}$	ERROR Threshold Voltage	See Figure 2	_	0.95 x V <sub>R</sub>	_	V
V <sub>HYS</sub>	ERROR Positive Hysteresis	Note 7	_	50	_	mV

NOTES: 1. V<sub>R</sub> is the regulator output voltage setting. For Example: V<sub>R</sub> = 2.5V, 2.7V, 2.85V, 3.0V, 3.3V, 3.6V, 4.0V, 5.0V.

- 2. TC  $V_{OUT} = \frac{V_{OUT_{MAX}} V_{OUT_{MIN}} \times 10^6}{V_{OUT} \times \Delta T}$
- 3. Regulation is measured at a constant junction temperature using low duty cycle pulse testing. Load regulation is tested over a load range from 0.1 mA to the maximum specified output current. Changes in output voltage due to heating effects are covered by the thermal regulation specification.
- 4. Dropout voltage is defined as the input to output differential at which the output voltage drops 2% below its nominal value.
- 5. Thermal Regulation is defined as the change in output voltage at a time T after a change in power dissipation is applied, excluding load or line regulation effects. Specifications are for a current pulse equal to I<sub>LMAX</sub> at V<sub>IN</sub> = 6V for T = 10 msec.
- 6. The maximum allowable power dissipation is a function of ambient temperature, the maximum allowable junction temperature and the thermal resistance from junction-to-air (i.e. T<sub>A</sub>, T<sub>J</sub>, θ<sub>JA</sub>). Exceeding the maximum allowable power dissipation causes the device to initiate thermal shutdown. Please see **Thermal Considerations** section of this data sheet for more details.
- 7. Hysteresis voltage is referenced by  $V_{R}$ .
- 8. Apply for Junction Temperatures of 40°C to +85°C.

#### TYPICAL APPLICATION



### PIN DESCRIPTION

Pin No. (5-Pin SOT-23A)	Symbol	Description
4		•
1	V <sub>IN</sub>	Unregulated supply input.
2	GND	Ground terminal.
3	SHDN	Shutdown control input. The regulator is fully enabled when a logic high is applied to this input. The regulator enters shutdown when a logic low is applied to this input. During shutdown, output voltage falls to zero, ERROR is open circuited and supply current is reduced to 0.5 µA (max).
4	ERROR	Out-of-Regulation Flag. (Open drain output). This output goes low when $V_{OUT}$ is out-of-tolerance by approximately $-$ 5%.
5	V <sub>OUT</sub>	Regulated voltage output.

#### **DETAILED DESCRIPTION**

The TC1054, TC1055, and TC1186 are precision fixed output voltage regulators. (If an adjustable version is desired, please see the TC1070, TC1071 or TC1187 data sheets.) Unlike bipolar regulators, the TC1054, TC1055, and TC1186 supply current does not increase with load current. In addition,  $V_{OUT}$  remains stable and within regulation at very low load currents (an important consideration in RTC and CMOS RAM battery back-up applications).

Figure 1 shows a typical application circuit. The regulator is enabled any time the shutdown input ( $\overline{SHDN}$ ) is at or above V<sub>IH</sub>, and shutdown (disabled) when  $\overline{SHDN}$  is at or below V<sub>IL</sub>.  $\overline{SHDN}$  may be controlled by a CMOS logic gate, or I/O port of a microcontroller. If the  $\overline{SHDN}$  input is not required, it should be connected directly to the input supply. While in shutdown, supply current decreases to  $0.05\mu A$  (typical), V<sub>OUT</sub> falls to zero volts, and  $\overline{ERROR}$  is opencircuited.

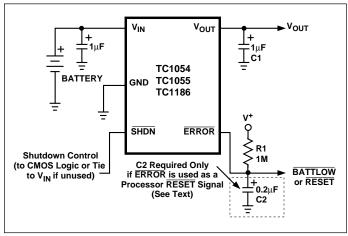


Figure 1. Typical Application Circuit

## **ERROR** Open Drain Output

ERROR is driven low whenever  $V_{OUT}$  falls out of regulation by more than -5% (typical). This condition may be caused by low input voltage, output current limiting, or thermal limiting. The  $\overline{ERROR}$  threshold is 5% below rated  $V_{OUT}$  regardless of the programmed output voltage value (e.g.  $\overline{ERROR} = V_{OL}$  at 4.75V (typ.) for a 5.0V regulator and 2.85V (typ.) for a 3.0V regulator).  $\overline{ERROR}$  output operation is shown in Figure 2.

Note that  $\overline{\mathsf{ERROR}}$  is active when  $\mathsf{V}_\mathsf{OUT}$  falls to  $\mathsf{V}_\mathsf{TH}$ , and inactive when  $\mathsf{V}_\mathsf{OUT}$  rises above  $\mathsf{V}_\mathsf{TH}$  by  $\mathsf{V}_\mathsf{HYS}$ .

As shown in Figure 1,  $\overline{\text{ERROR}}$  can be used as a battery low flag, or as a processor  $\overline{\text{RESET}}$  signal (with the addition of timing capacitor C2). R1 x C2 should be chosen to maintain  $\overline{\text{ERROR}}$  below  $V_{\text{IH}}$  of the processor  $\overline{\text{RESET}}$  input for at least 200 msec to allow time for the system to stabilize.

Pull-up resistor R1 can be tied to  $V_{OUT}$ ,  $V_{IN}$  or any other voltage less than ( $V_{IN}$  + 0.3V).

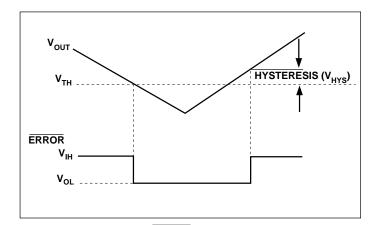


Figure 2. ERROR Output Operation

### **Output Capacitor**

A 1µF(min) capacitor from V<sub>OUT</sub> to ground is recommended. The output capacitor should have an effective series resistance of  $5\Omega$  or less, and a resonant frequency above 1MHz. A 1µF capacitor should be connected from V<sub>IN</sub> to GND if there is more than 10 inches of wire between the regulator and the AC filter capacitor, or if a battery is used as the power source. Aluminum electrolytic or tantalum capacitor types can be used. (Since many aluminum electrolytic capacitors freeze at approximately – 30°C, solid tantalums are recommended for applications operating below – 25°C.) When operating from sources other than batteries, supply-noise rejection and transient response can be improved by increasing the value of the input and output capacitors and employing passive filtering techniques.

#### **Thermal Considerations**

#### **Thermal Shutdown**

Integrated thermal protection circuitry shuts the regulator off when die temperature exceeds  $160^{\circ}$ C. The regulator remains off until the die temperature drops to approximately  $150^{\circ}$ C.

### **Power Dissipation**

The amount of power the regulator dissipates is primarily a function of input and output voltage, and output current. The following equation is used to calculate worst case *actual* power dissipation:

$$P_{D \approx} (V_{IN_{MAX}} - V_{OUT_{MIN}})I_{LOAD_{MAX}}$$

Where:

P<sub>D</sub> = Worst case actual power dissipation

 $V_{IN_{MAX}}$  = Maximum voltage on  $V_{IN}$ 

V<sub>OUTMIN</sub> = Minimum regulator output voltage

 $I_{LOAD_{MAX}}$  = Maximum output (load) current

#### Equation 1.

The maximum *allowable* power dissipation (Equation 2) is a function of the maximum ambient temperature ( $T_{AMAX}$ ), the maximum allowable die temperature ( $125^{\circ}C$ ) and the thermal resistance from junction-to-air ( $\theta_{JA}$ ). 5-Pin SOT-23A package has a  $\theta_{JA}$  of approximately  $220^{\circ}C/Watt$  when mounted on a single layer FR4 dielectric copper clad PC board.

$$P_{D_{MAX}} = (\underline{T_{J_{MAX}} - T_{A_{MAX}}})$$

Where all terms are previously defined.

### Equation 2.

Equation 1 can be used in conjunction with Equation 2 to ensure regulator thermal operation is within limits. For example:

Given:

$$V_{\text{IN}_{\text{MAX}}} = 3.0 \text{V} \pm 5\%$$

$$V_{\text{OUT}_{\text{MIN}}} = 2.7 \text{V} - 2.5\%$$

$$I_{\text{LOAD}} = 40 \text{mA}$$

$$T_{\text{AMAX}} = 55^{\circ}\text{C}$$

Find:

1. Actual power dissipation

2. Maximum allowable dissipation

Actual power dissipation:

$$P_{D \approx} (V_{IN_{MAX}} - V_{OUT_{MIN}})I_{LOAD_{MAX}}$$
  
= [(3.0 x 1.05) - (2.7 x .975)]40 x 10<sup>-3</sup>  
= 20.7mW

Maximum allowable power dissipation:

$$P_{DMAX} = \underbrace{(T_{J_{MAX}} - T_{A_{MAX}})}_{\theta_{JA}}$$

$$= \underbrace{(125 - 55)}_{220}$$

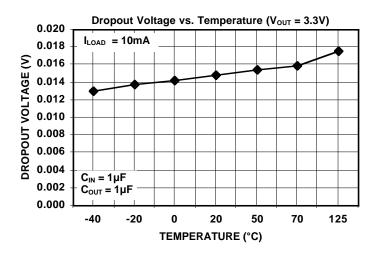
$$= 318 \text{mW}$$

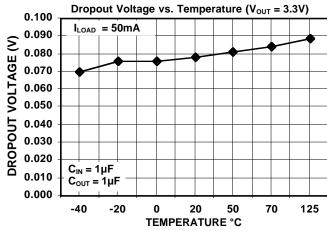
In this example, the TC1054 dissipates a maximum of only 20.7mW; far below the allowable limit of 318mW. In a similar manner, Equation 1 and Equation 2 can be used to calculate maximum current and/or input voltage limits.

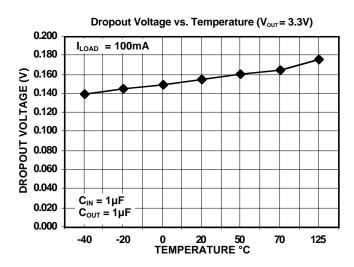
#### **Layout Considerations**

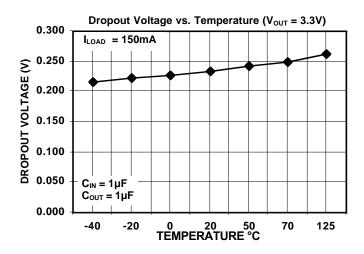
The primary path of heat conduction out of the package is via the package leads. Therefore, layouts having a ground plane, wide traces at the pads, and wide power supply bus lines combine to lower  $\theta_{JA}$  and therefore increase the maximum allowable power dissipation limit.

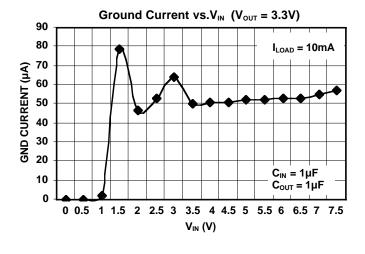
### TYPICAL CHARACTERISTICS: (Unless otherwise specified, all parts are measured at Temperature = 25°C)

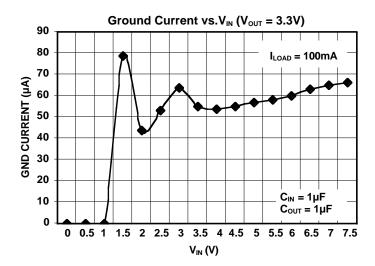




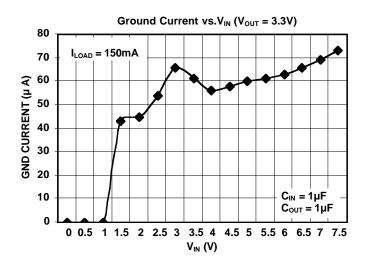


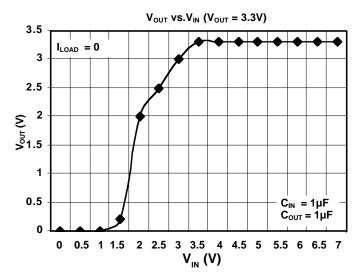


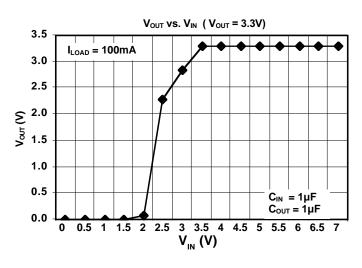


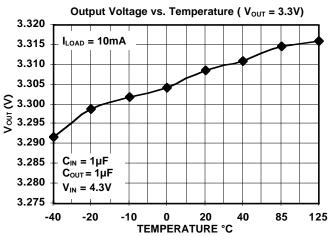


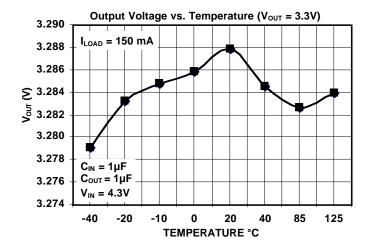
### TYPICAL CHARACTERISTICS: (Unless otherwise specified, all parts are measured at Temperature = 25°C



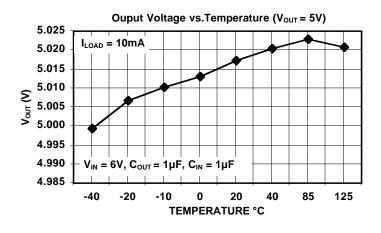


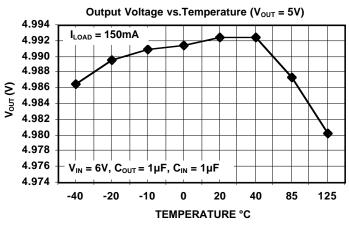


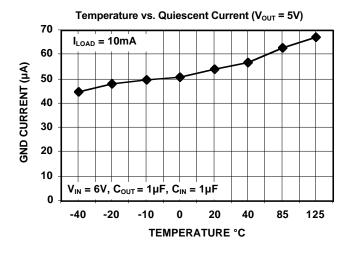


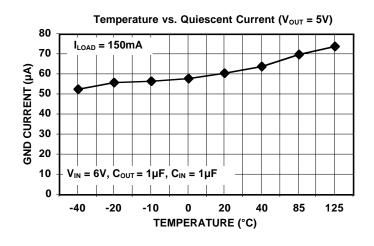


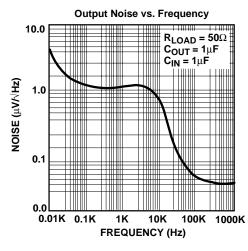
## TYPICAL CHARACTERISTICS

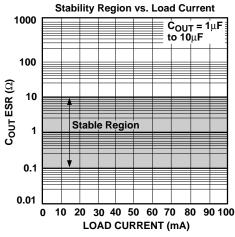


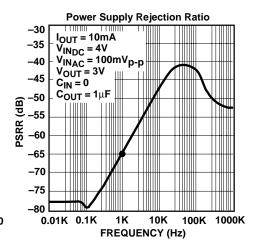








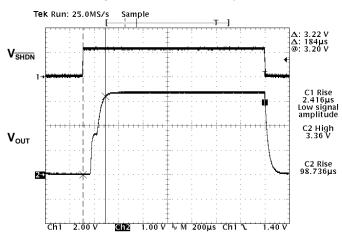




### TYPICAL CHARACTERISTICS

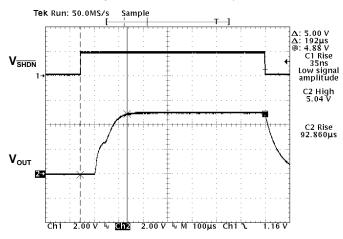
#### Measure Rise Time of 3.3V LDO

Conditions:  $C_{IN}=1\mu F$ ,  $C_{OUT}=1\mu F$ ,  $I_{LOAD}=100mA$ ,  $V_{IN}=4.3V$ ,  $Temp=25^{\circ}C, Rise\ Time=184\mu S$ 



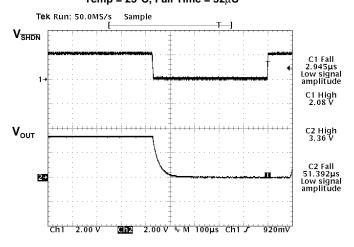
#### Measure Rise Time of 5.0V LDO

Conditions:  $C_{IN} = 1\mu F$ ,  $C_{OUT} = 1\mu F$ ,  $I_{LOAD} = 100mA$ ,  $V_{IN} = 6V$ ,  $Temp = 25^{\circ}C$ , Rise Time = 192 $\mu$ S



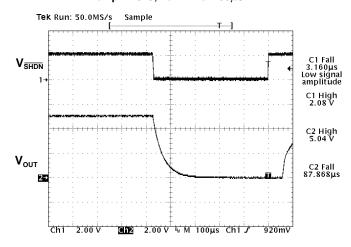
#### Measure Fall Time of 3.3V LDO

$$\label{eq:conditions: C_IN} \begin{split} \text{Conditions: C}_{\text{IN}} &= 1 \mu \text{F, C}_{\text{OUT}} = 1 \mu \text{F, I}_{\text{LOAD}} = 100 \text{mA, V}_{\text{IN}} = 4.3 \text{V,} \\ \text{Temp} &= 25^{\circ} \text{C, Fall Time} = 52 \mu \text{S} \end{split}$$



#### Measure Fall Time of 5.0V LDO

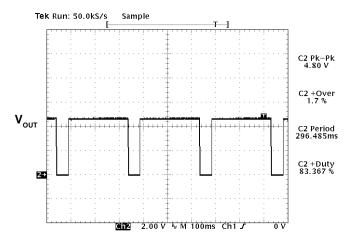
 $\begin{aligned} \text{Conditions: } C_{\text{IN}} &= 1 \mu F, \, C_{\text{OUT}} = 1 \mu F, \, I_{\text{LOAD}} = 100 \text{mA}, \, V_{\text{IN}} = 6 V, \\ \text{Temp} &= 25^{\circ} C, \, \text{Fall Time} = 88 \mu S \end{aligned}$ 



### TYPICAL CHARACTERISTICS

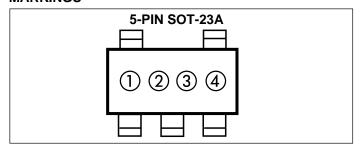
#### Thermal Shutdown Response of 5.0V LDO

Conditions:  $V_{IN} = 6V, C_{IN} = 0\mu F, C_{OUT} = 1\mu F$ 



 $I_{\text{LOAD}}$  was increased until temperature of die reached about 160°C, at which time integrated thermal protection circuitry shuts the regulator off when die temperature exceeds approximately 160°C. The regulator remains off until die temperature drops to approximately 150°C.

#### **MARKINGS**

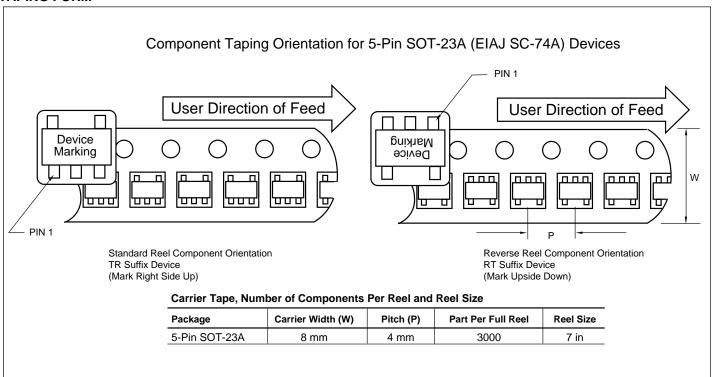


① & ② = part number code + temperature range and voltage

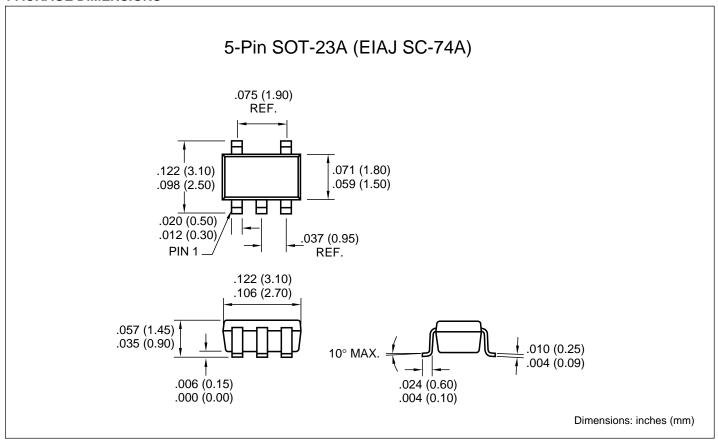
<u>(V)</u>	TC1054 Code	TC1055 Code	<u>TC1186 Code</u>
2.5	C1	D1	P1
2.7	C2	D2	P2
2.8	CZ	DZ	PZ
2.85	C8	D8	P8
3.0	C3	D3	P3
3.3	C5	D5	P5
3.6	C9	D9	P9
4.0	C0	D0	P0
5.0	C7	D7	P7

- (3) represents year and quarter code
- 4 represents lot ID number

#### **TAPING FORM**



#### **PACKAGE DIMENSIONS**





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